MOSFET - SiC Power, Single N-Channel, D2PAK-7L

1200 V, 40 mΩ, 60 A

NVBG040N120SC1

Features

- Typ. $R_{DS(on)} = 40 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_{G(tot)} = 106 \text{ nC}$)
- Low Effective Output Capacitance (Typ. C_{oss} = 139 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

Typical Applications

- Automotive On Board Charger
- Automotive DC/DC Converter for EV/HEV

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	1200	V
Gate-to-Source Voltaç	ge		V _{GS}	+25/-15	V
Recommended Operat of Gate – Source Volta		T _C < 175°C	V_{GSop}	+20/-5	V
Continuous Drain Current (Note 1)	Steady State	T _C = 25°C	I _D	60	Α
Power Dissipation (Note 1)			P _D	357	W
Continuous Drain Current (Note 1)	Steady State	T _C = 100°C	I _D	43	Α
Power Dissipation (Note 1)			P _D	178	W
Pulsed Drain Current (Note 2) T _A = 25°C			I _{DM}	240	Α
Single Pulse Surge Drain Current Capa- bility	T _A = 25°C R _G =	C, t _p = 10 μs, = 4.7 Ω	I _{DSC}	416	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			IS	36	Α
Single Pulse Drain-to-Source Avalanche Energy (I _L = 34 A _{pk} , L = 1 mH) (Note 3)			E _{AS}	578	mJ
Maximum Lead Temperature for Soldering, 1/8" from Case for 10 Seconds			TL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

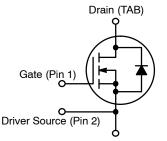
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Repetitive rating, limited by max junction temperature.
- 3. E_{AS} of 578 mJ is based on starting $T_J = 25^{\circ} \dot{C}$; L = 1 mH, $I_{AS} = 34$ A, $V_{DD} = 120$ V, $V_{GS} = 18$ V.



ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
1200 V	56 mΩ @ 20 V	60 A	



Power Source (Pins 3, 4, 5, 6, 7)

N-CHANNEL MOSFET



D2PAK-7L CASE 418BJ

MARKING DIAGRAM

AYWWZZ NVBG 040120SC1

A = Assembly Location

Y = Year WW = Work Week ZZ = Lot Traceability

NVBG040120SC1 = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

Table 1. THERMAL CHARACTERISTICS

Parameter	Symbol	Max	Units
Thermal Resistance Junction-to-Case (Note 1)	$R_{ heta JC}$	0.42	°C/W
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{ hetaJA}$	40	°C/W

Table 2. ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise stated)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 \	/, I _D = 1 mA	1200			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 1 mA, refer to 25°C			0.45		V/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	T _J = 25°C			100	μΑ
		V _{DS} = 1200 V	T _J = 175°C			1	mA
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = +25/-	15 V, V _{DS} = 0 V			±1	μΑ
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$	s, I _D = 10 mA	1.8	3	4.3	V
Recommended Gate Voltage	V _{GOP}			-5		+20	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 20 V, I _D :	= 35 A, T _J = 25°C		40	56	mΩ
		V _{GS} = 20 V, I _D =	: 35 A, T _J = 175°C		71	100	mΩ
Forward Transconductance	9FS	V _{DS} = 20	V, I _D = 35 A		20		S
CHARGES, CAPACITANCES & GATE RESI	STANCE				•		
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 800 V			1789		pF
Output Capacitance	C _{OSS}				139		
Reverse Transfer Capacitance	C _{RSS}				12.5		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -5/20 \text{ V}, V_{DS} = 600 \text{ V},$ $I_{D} = 47 \text{ A}$			106		nC
Threshold Gate Charge	Q _{G(TH)}				18		
Gate-to-Source Charge	Q_{GS}				34		
Gate-to-Drain Charge	Q_{GD}				26		
Gate-Resistance	R_{G}	f = 1 MHz			2		Ω
SWITCHING CHARACTERISTICS (Note 4)							
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -5/20 \text{ V}, V_{DS} = 800 \text{ V},$			17	30	ns
Rise Time	t _r		$R_G = 4.7 \Omega$, ive Load		20	36	
Turn-Off Delay Time	t _{d(OFF)}				30	48	
Fall Time	t _f				9	18	
Turn-On Switching Loss	E _{ON}				366		μJ
Turn-Off Switching Loss	E _{OFF}				200		
Total Switching Loss	E _{TOT}				566		
DRAIN-SOURCE DIODE CHARACTERISTIC	cs						
Continuous Drain-Source Diode Forward Current	I _{SD}	V _{GS} = -5	V, T _J = 25°C			36	Α
Pulsed Drain-Source Diode Forward Current (Note 2)	I _{SDM}	V _{GS} = -5 V, T _J = 25°C				240	Α
Forward Diode Voltage	V _{SD}	$V_{GS} = -5 \text{ V}, I_{SD} =$	= 17.5 A, T _J = 25°C		3.7		٧

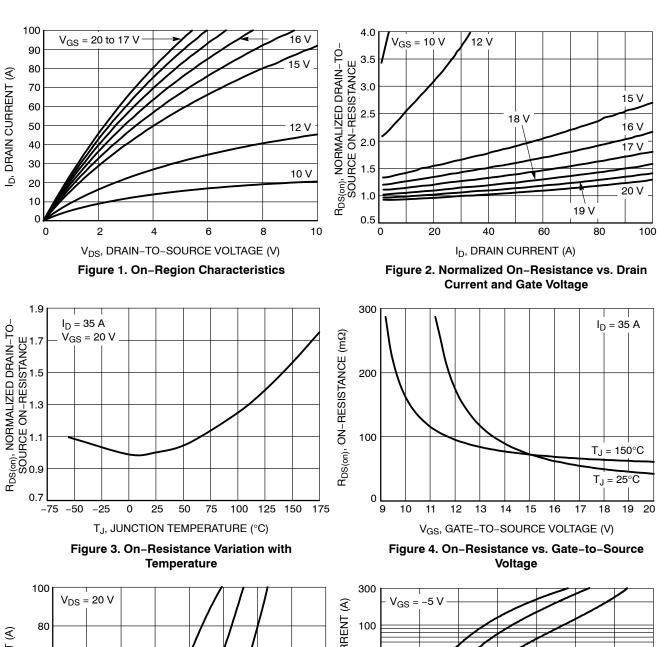
Table 2. ELECTRICAL CHARACTERISTICS (T_{.J} = 25°C unless otherwise stated)

Table 2. ELLOTTIONE OF ATTACK (1) - 20 O difference of attack)							
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS							
Reverse Recovery Time	t _{RR}	$V_{GS} = -5/20 \text{ V, } I_{SD} = 47 \text{ A,} \\ dI_{S}/dt = 1000 \text{ A/}\mu\text{s}$		24		ns	
Reverse Recovery Charge	Q _{RR}			124.8		nC	
Reverse Recovery Energy	E _{REC}			8.4		μJ	
Peak Reverse Recovery Current	I _{RRM}			10.4		Α	
Charge time	Ta			12.4		ns	
Discharge time	Tb			11.6		ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Switching characteristics are independent of operating junction temperature

TYPICAL CHARACTERISTICS



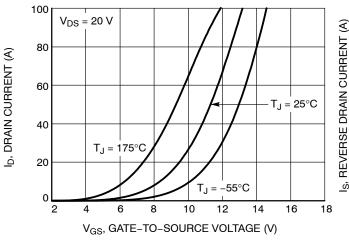


Figure 5. Transfer Characteristics

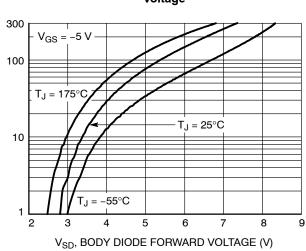
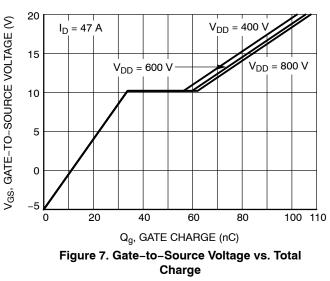


Figure 6. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS



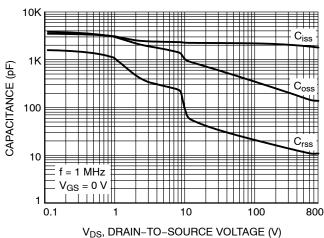


Figure 8. Capacitance vs. Drain-to-Source

Voltage

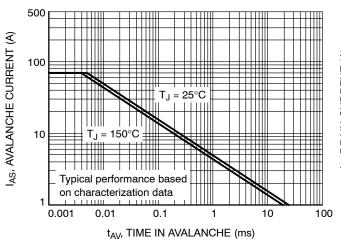


Figure 9. Unclamped Inductive Switching Capability

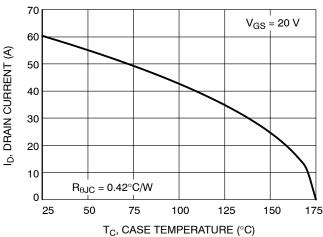


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

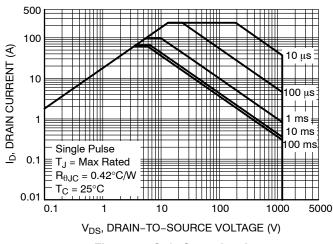


Figure 11. Safe Operating Area

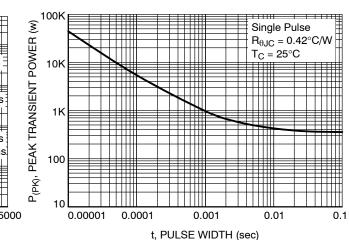


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS

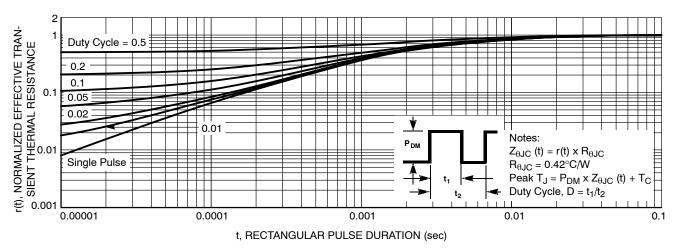


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

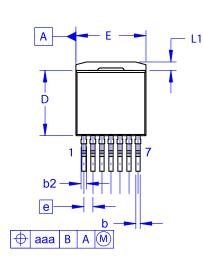
DEVICE ORDERING INFORMATION

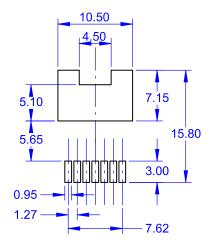
Device	Package	Shipping [†]
NVBG040N120SC1	D2PAK-7L	800 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

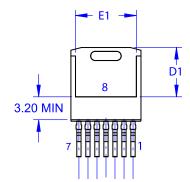
PACKAGE DIMENSIONS

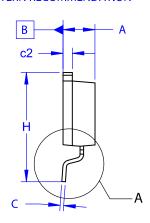
D²PAK7 (TO-263-7L HV) CASE 418BJ **ISSUE B**





LAND PATTERN RECOMMENDATION





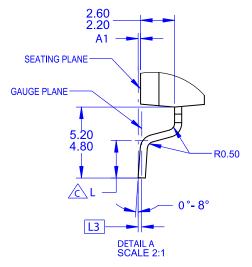
NOTES:

- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED. B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE.

 D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.

 E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

DIM	MIL	LIMETER	S
DIM	MIN	NOM	MAX
Α	4.30	4.50	4.70
A1	0.00	0.10	0.20
b2	0.60	0.70	0.80
b	0.51	0.60	0.70
С	0.40	0.50	0.60
c2	1.20	1.30	1.40
D	9.00	9.20	9.40
D1	6.15	6.80	7.15
Е	9.70	9.90	10.20
E1	7.15	7.65	8.15
е	~	1.27	7
Н	15.10	15.40	15.70
L	2.44	2.64	2.84
L1	1.00	1.20	1.40
L3	~	0.25	٠
aaa	~	~	0.25



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